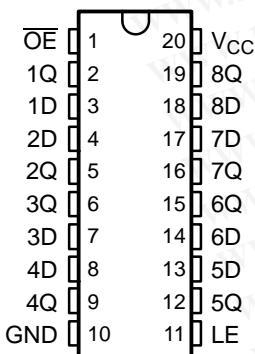


FEATURES

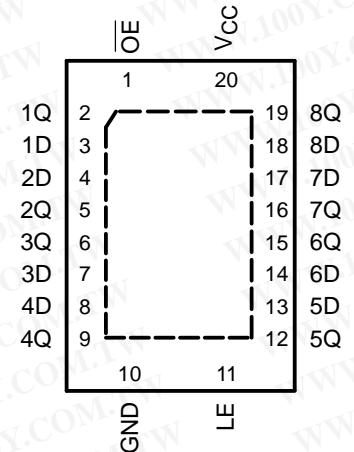
- Operate From 1.65 V to 3.6 V
- Inputs Accept Voltages to 5.5 V
- Max t_{pd} of 6.8 ns at 3.3 V
- Typical V_{OLP} (Output Ground Bounce) < 0.8 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$
- Typical V_{OHV} (Output V_{OH} Undershoot) > 2 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$
- Support Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V V_{CC})

- I_{off} Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

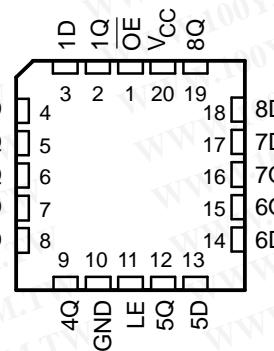
SN54LVC373A . . . J OR W PACKAGE
**SN74LVC373A . . . DB, DGV, DW, N,
 NS, OR PW PACKAGE**
(TOP VIEW)



SN74LVC373A . . . RGY PACKAGE
(TOP VIEW)



SN54LVC373A . . . FK PACKAGE
(TOP VIEW)



DESCRIPTION/ORDERING INFORMATION

The SN54LVC373A octal transparent D-type latch is designed for 2.7-V to 3.6-V V_{CC} operation, and the SN74LVC373A octal transparent D-type latch is designed for 1.65-V to 3.6-V V_{CC} operation.

While the latch-enable (LE) input is high, the Q outputs follow the data (D) inputs. When LE is taken low, the Q outputs are latched at the logic levels set up at the D inputs.

A buffered output-enable (\overline{OE}) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without interface or pullup components.

\overline{OE} does not affect the internal operations of the latches. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

These devices are fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of these devices as translators in a mixed 3.3-V/5-V system environment.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

**SN54LVC373A, SN74LVC373A
OCTAL TRANSPARENT D-TYPE LATCHES
WITH 3-STATE OUTPUTS**

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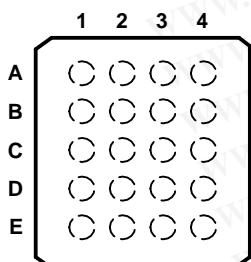
DESCRIPTION/ORDERING INFORMATION (CONTINUED)

ORDERING INFORMATION

T _A	PACKAGE ⁽¹⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 85°C	PDIP – N	Tube of 20	SN74LVC373AN	SN74LVC373AN
	QFN – RGY	Reel of 1000	SN74LVC373ARGYR	LC373A
	SOIC – DW	Tube of 25	SN74LVC373ADW	LVC373A
		Reel of 2000	SN74LVC373ADWR	
	SOP – NS	Reel of 2000	SN74LVC373ANSR	LVC373A
	SSOP – DB	Reel of 2000	SN74LVC373ADBR	LC373A
	TSSOP – PW	Tube of 70	SN74LVC373APW	LC373A
		Reel of 2000	SN74LVC373APWR	
		Reel of 250	SN74LVC373APWT	
	TVSOP – DGV	Reel of 2000	SN74LVC373ADGVR	LC373A
	VFBGA – GQN	Reel of 1000	SN74LVC373AGQNR	LC373A
	VFBGA – ZQN (Pb-free)		SN74LVC373AZQNR	
–55°C to 125°C	CDIP – J	Tube of 20	SNJ54LVC373AJ	SNJ54LVC373AJ
	CFP – W	Tube of 85	SNJ54LVC373AW	SNJ54LVC373AW
	LCCC – FK	Tube of 55	SNJ54LVC373AFK	SNJ54LVC373AFK

- (1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

**GQN OR ZQN PACKAGE
(TOP VIEW)**



TERMINAL ASSIGNMENTS

	1	2	3	4
A	1Q	OE	V _{CC}	8Q
B	2D	7D	1D	8D
C	3Q	2Q	6Q	7Q
D	4D	5D	3D	6D
E	GND	4Q	LE	5Q

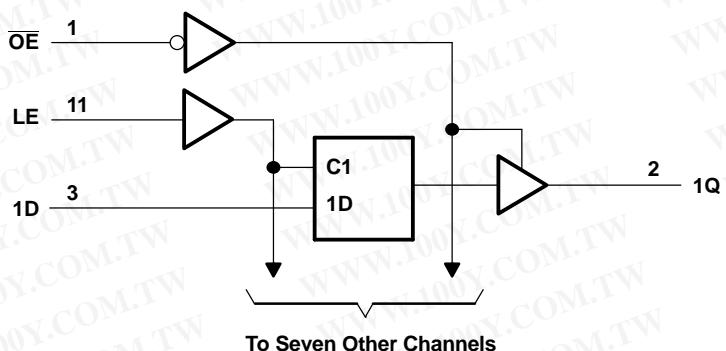
**FUNCTION TABLE
(EACH LATCH)**

INPUTS			OUTPUT
OE	LE	D	Q
L	H	H	H
L	H	L	L
L	L	X	Q ₀
H	X	X	Z

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LOGIC DIAGRAM (POSITIVE LOGIC)



Pin numbers shown are for the DB, DGV, DW, FK, J, N, NS, PW, RGY, and W packages.

Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V _{CC}	Supply voltage range	-0.5	6.5	V
V _I	Input voltage range ⁽²⁾	-0.5	6.5	V
V _O	Voltage range applied to any output in the high-impedance or power-off state ⁽²⁾	-0.5	6.5	V
V _O	Voltage range applied to any output in the high or low state ⁽²⁾⁽³⁾	-0.5	V _{CC} + 0.5	V
I _{IK}	Input clamp current	V _I < 0	-50	mA
I _{OK}	Output clamp current	V _O < 0	-50	mA
I _O	Continuous output current		±50	mA
	Continuous current through V _{CC} or GND		±100	mA
θ _{JA}	Package thermal impedance	DB package ⁽⁴⁾	70	°C/W
		DGV package ⁽⁴⁾	92	
		DW package ⁽⁴⁾	58	
		GQN/ZQN package ⁽⁴⁾	78	
		N package ⁽⁴⁾	69	
		NS package ⁽⁴⁾	60	
		PW package ⁽⁴⁾	83	
		RGY package ⁽⁵⁾	37	
T _{stg}	Storage temperature range	-65	150	°C

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) The value of V_{CC} is provided in the recommended operating conditions table.
- (4) The package thermal impedance is calculated in accordance with JESD 51-7.
- (5) The package thermal impedance is calculated in accordance with JESD 51-5.

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**SN54LVC373A, SN74LVC373A
OCTAL TRANSPARENT D-TYPE LATCHES
WITH 3-STATE OUTPUTS**

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Recommended Operating Conditions⁽¹⁾

		SN54LVC373A		SN74LVC373A		UNIT		
		MIN	MAX	MIN	MAX			
V _{CC}	Supply voltage	Operating		2	3.6	1.65	3.6	V
		Data retention only		1.5		1.5		
V _{IH}	High-level input voltage	V _{CC} = 1.65 V to 1.95 V			0.65 × V _{CC}		V	
		V _{CC} = 2.3 V to 2.7 V			1.7			
		V _{CC} = 2.7 V to 3.6 V		2		2		
V _{IL}	Low-level input voltage	V _{CC} = 1.65 V to 1.95 V			0.35 × V _{CC}		V	
		V _{CC} = 2.3 V to 2.7 V			0.7			
		V _{CC} = 2.7 V to 3.6 V		0.8		0.8		
V _I	Input voltage			0	5.5	0	5.5	V
V _O	Output voltage	High or low state		0	V _{CC}	0	V _{CC}	V
		3-state		0	5.5	0	5.5	
I _{OH}	High-level output current	V _{CC} = 1.65 V				-4	mA	
		V _{CC} = 2.3 V				-8		
		V _{CC} = 2.7 V		-12		-12		
		V _{CC} = 3 V		-24		-24		
I _{OL}	Low-level output current	V _{CC} = 1.65 V				4	mA	
		V _{CC} = 2.3 V				8		
		V _{CC} = 2.7 V		12		12		
		V _{CC} = 3 V		24		24		
Δt/Δv	Input transition rise or fall rate			10		10	ns/V	
T _A	Operating free-air temperature			-55	125	-40	85	°C

- (1) All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

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Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V_{CC}	SN54LVC373A			SN74LVC373A			UNIT
			MIN	TYP ⁽¹⁾	MAX	MIN	TYP ⁽¹⁾	MAX	
V_{OH}	$I_{OH} = -100 \mu A$	1.65 V to 3.6 V				$V_{CC} - 0.2$			V
		2.7 V to 3.6 V		$V_{CC} - 0.2$					
	$I_{OH} = -4 mA$	1.65 V				1.2			
	$I_{OH} = -8 mA$	2.3 V				1.7			
	$I_{OH} = -12 mA$	2.7 V		2.2		2.2			
		3 V		2.4		2.4			
V_{OL}	$I_{OL} = 100 \mu A$	1.65 V to 3.6 V						0.2	V
		2.7 V to 3.6 V				0.2			
	$I_{OL} = 4 mA$	1.65 V						0.45	
	$I_{OL} = 8 mA$	2.3 V						0.7	
	$I_{OL} = 12 mA$	2.7 V			0.4			0.4	
	$I_{OL} = 24 mA$	3 V			0.55			0.55	
I_I	$V_I = 0$ to 5.5 V	3.6 V			± 5			± 5	μA
I_{off}	V_I or $V_O = 5.5 V$	0						± 10	μA
I_{OZ}	$V_O = 0$ to 5.5 V	3.6 V			± 15			± 10	μA
I_{CC}	$V_I = V_{CC}$ or GND	3.6 V			10			10	μA
	$3.6 V \leq V_I \leq 5.5 V^{(2)}$				10			10	
ΔI_{CC}	One input at $V_{CC} - 0.6 V$, Other inputs at V_{CC} or GND	2.7 V to 3.6 V			500			500	μA
C_i	$V_I = V_{CC}$ or GND	3.3 V			4	12		4	pF
C_o	$V_O = V_{CC}$ or GND	3.3 V			5.5	12		5.5	pF

(1) All typical values are at $V_{CC} = 3.3 V$, $T_A = 25^\circ C$.

(2) This applies in the disabled state only.

Timing Requirements

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

		SN54LVC373A				UNIT	
		$V_{CC} = 2.7 V$		$V_{CC} = 3.3 V \pm 0.3 V$			
		MIN	MAX	MIN	MAX		
t_w	Pulse duration, LE high			3.3	3.3	ns	
t_{su}	Setup time, data before LE↓			2	2	ns	
t_h	Hold time, data after LE↓			2	2	ns	

Timing Requirements

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

		SN74LVC373A								UNIT	
		$V_{CC} = 1.8 V \pm 0.15 V$		$V_{CC} = 2.5 V \pm 0.2 V$		$V_{CC} = 2.7 V$		$V_{CC} = 3.3 V \pm 0.3 V$			
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX		
t_w	Pulse duration, LE high	(1)		(1)		3.3		3.3		ns	
t_{su}	Setup time, data before LE↓	(1)		(1)		2		2		ns	
t_h	Hold time, data after LE↓	(1)		(1)		1.5		1.5		ns	

(1) This information was not available at the time of publication.

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**SN54LVC373A, SN74LVC373A
OCTAL TRANSPARENT D-TYPE LATCHES
WITH 3-STATE OUTPUTS**

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Switching Characteristics

over recommended operating free-air temperature range (unless otherwise noted) (see [Figure 1](#))

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54LVC373A				UNIT	
			V _{CC} = 2.7 V		V _{CC} = 3.3 V ± 0.3 V			
			MIN	MAX	MIN	MAX		
t _{pd}	D	Q	8.5	1	7.5		ns	
	LE		9.5	1	8.5			
t _{en}	OE	Q	8.7	1	7.7	ns		
t _{dis}	OE	Q	8	0.5	7	ns		

Switching Characteristics

over recommended operating free-air temperature range (unless otherwise noted) (see [Figure 1](#))

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN74LVC373A						UNIT	
			V _{CC} = 1.8 V ± 0.15 V		V _{CC} = 2.5 V ± 0.2 V		V _{CC} = 2.7 V			
			MIN	MAX	MIN	MAX	MIN	MAX		
t _{pd}	D	Q	(1)	(1)	(1)	(1)	7.8	1.5	6.8	ns
	LE		(1)	(1)	(1)	(1)	8.2	2	7.6	
t _{en}	OE	Q	(1)	(1)	(1)	(1)	8.7	1.5	7.7	ns
t _{dis}	OE	Q	(1)	(1)	(1)	(1)	7.6	1.5	7	ns
t _{sk(o)}									1	ns

(1) This information was not available at the time of publication.

Operating Characteristics

T_A = 25°C

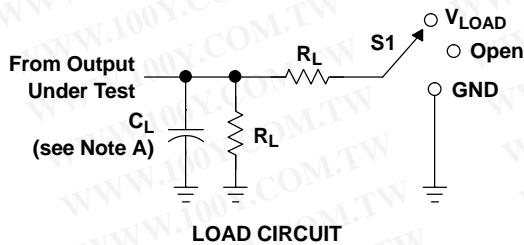
C _{pd}	Power dissipation capacitance per latch	TEST CONDITIONS	V _{CC} = 1.8 V	V _{CC} = 2.5 V	V _{CC} = 3.3 V	UNIT
			TYP	TYP	TYP	
			Outputs enabled	Outputs disabled	f = 10 MHz	
			(1)	(1)	46	pF
			(1)	(1)	3	

(1) This information was not available at the time of publication.

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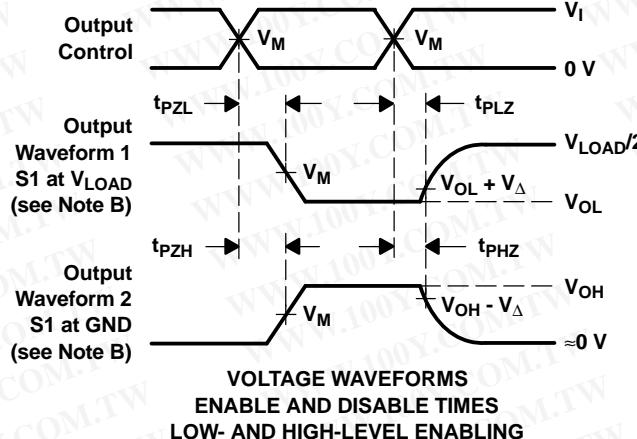
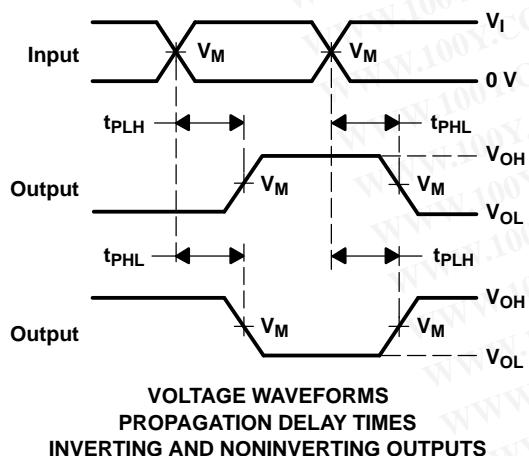
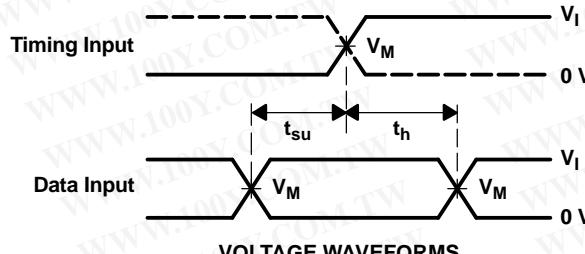
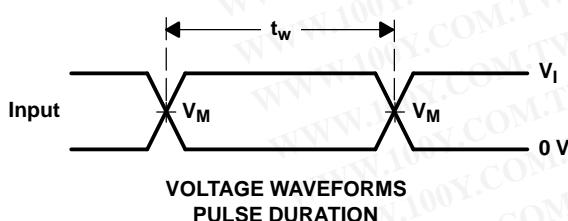
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PARAMETER MEASUREMENT INFORMATION



TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	V_{LOAD}
t_{PHZ}/t_{PZH}	GND

V_{CC}	INPUTS		V_M	V_{LOAD}	C_L	R_L	V_Δ
	V_I	t_r/t_f					
$1.8 \text{ V} \pm 0.15 \text{ V}$	V_{CC}	$\leq 2 \text{ ns}$	$V_{CC}/2$	$2 \times V_{CC}$	30 pF	1 k Ω	0.15 V
$2.5 \text{ V} \pm 0.2 \text{ V}$	V_{CC}	$\leq 2 \text{ ns}$	$V_{CC}/2$	$2 \times V_{CC}$	30 pF	500 Ω	0.15 V
2.7 V	2.7 V	$\leq 2.5 \text{ ns}$	1.5 V	6 V	50 pF	500 Ω	0.3 V
$3.3 \text{ V} \pm 0.3 \text{ V}$	2.7 V	$\leq 2.5 \text{ ns}$	1.5 V	6 V	50 pF	500 Ω	0.3 V



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR $\leq 10 \text{ MHz}$, $Z_O = 50 \Omega$.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en} .
- G. t_{PLH} and t_{PHL} are the same as t_{pd} .
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

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PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
5962-9757301Q2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
5962-9757301QRA	ACTIVE	CDIP	J	20	1	TBD	A42 SNPB	N / A for Pkg Type
5962-9757301QSA	ACTIVE	CFP	W	20	1	TBD	A42	N / A for Pkg Type
SN74LVC373ADBLE	OBsolete	SSOP	DB	20		TBD	Call TI	Call TI
SN74LVC373ADBR	ACTIVE	SSOP	DB	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC373ADBRE4	ACTIVE	SSOP	DB	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC373ADGVR	ACTIVE	TVSOP	DGV	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC373ADGVRE4	ACTIVE	TVSOP	DGV	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC373ADW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC373ADWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC373ADWRE4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC373AGQNR	ACTIVE	BGA MI CROSTA R JUNI OR	GQN	20	1000	TBD	SNPB	Level-1-240C-UNLIM
SN74LVC373AN	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LVC373ANE4	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LVC373ANSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC373ANSRE4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC373APW	ACTIVE	TSSOP	PW	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC373APWE4	ACTIVE	TSSOP	PW	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC373APWG4	ACTIVE	TSSOP	PW	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC373APWLE	OBsolete	TSSOP	PW	20		TBD	Call TI	Call TI
SN74LVC373APWR	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC373APWRE4	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC373APWRG4	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC373APWT	ACTIVE	TSSOP	PW	20	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC373APWTE4	ACTIVE	TSSOP	PW	20	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC373ARGYR	ACTIVE	QFN	RGY	20	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1YEAR

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN74LVC373ARGYRG4	ACTIVE	QFN	RGY	20	1000	TBD	Call TI	Call TI
SN74LVC373AZQNR	ACTIVE	BGA MI CROSTA R JUNI OR	ZQN	20	1000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM
SNJ54LVC373AFK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LVC373AJ	ACTIVE	CDIP	J	20	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54LVC373AW	ACTIVE	CFP	W	20	1	TBD	A42	N / A for Pkg Type

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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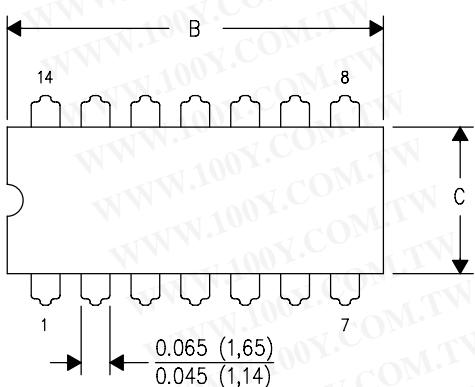
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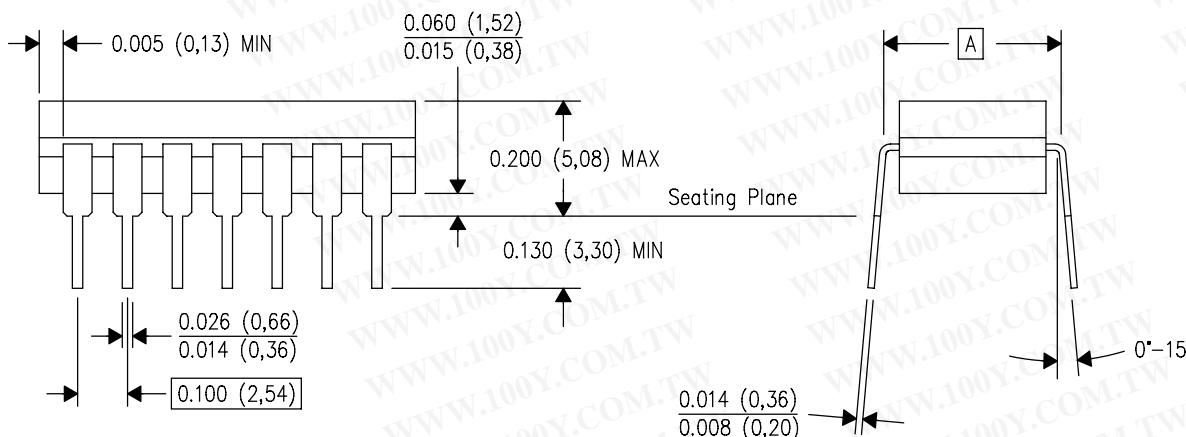
J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)

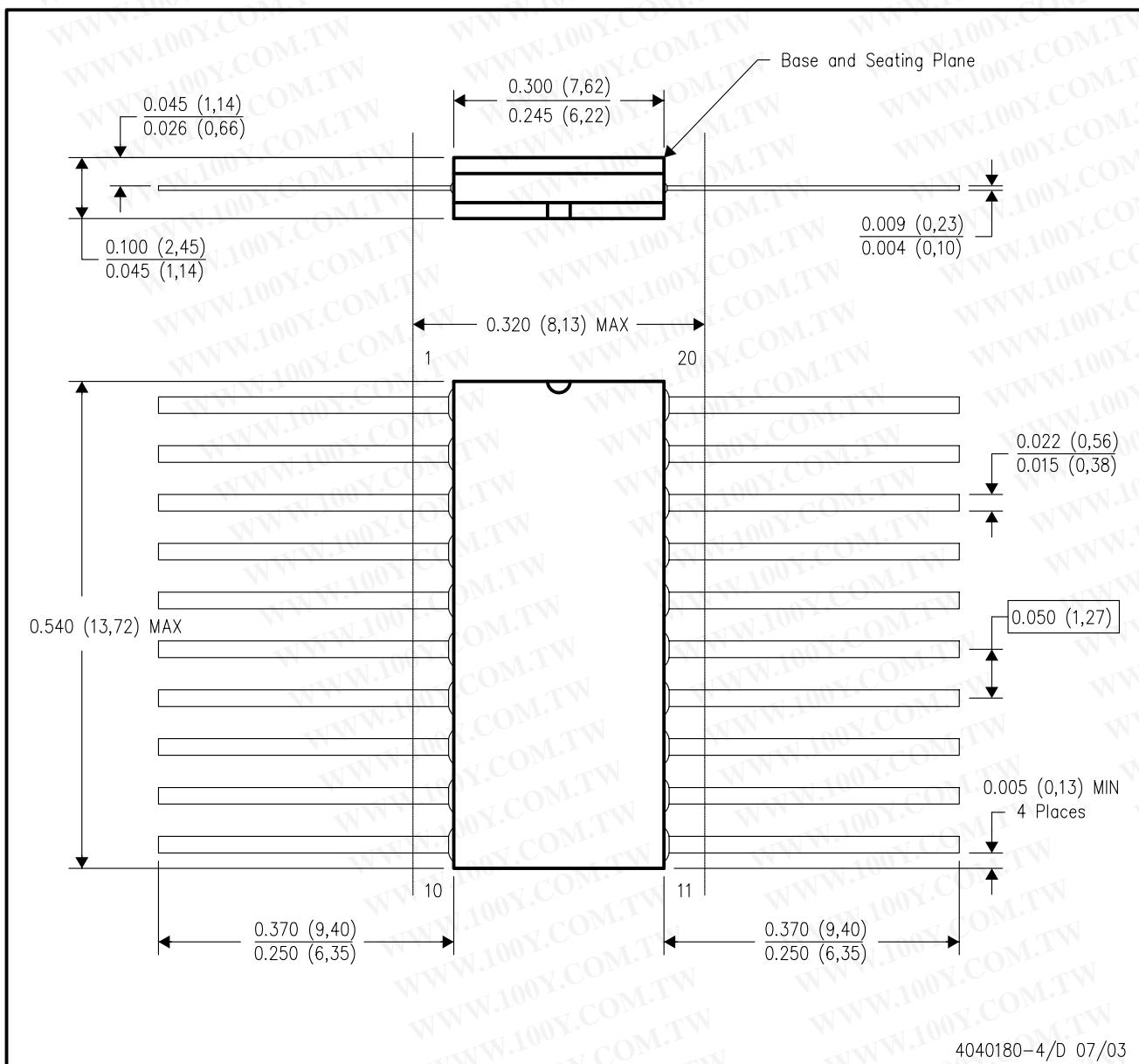


4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package is hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F20)

CERAMIC DUAL FLATPACK

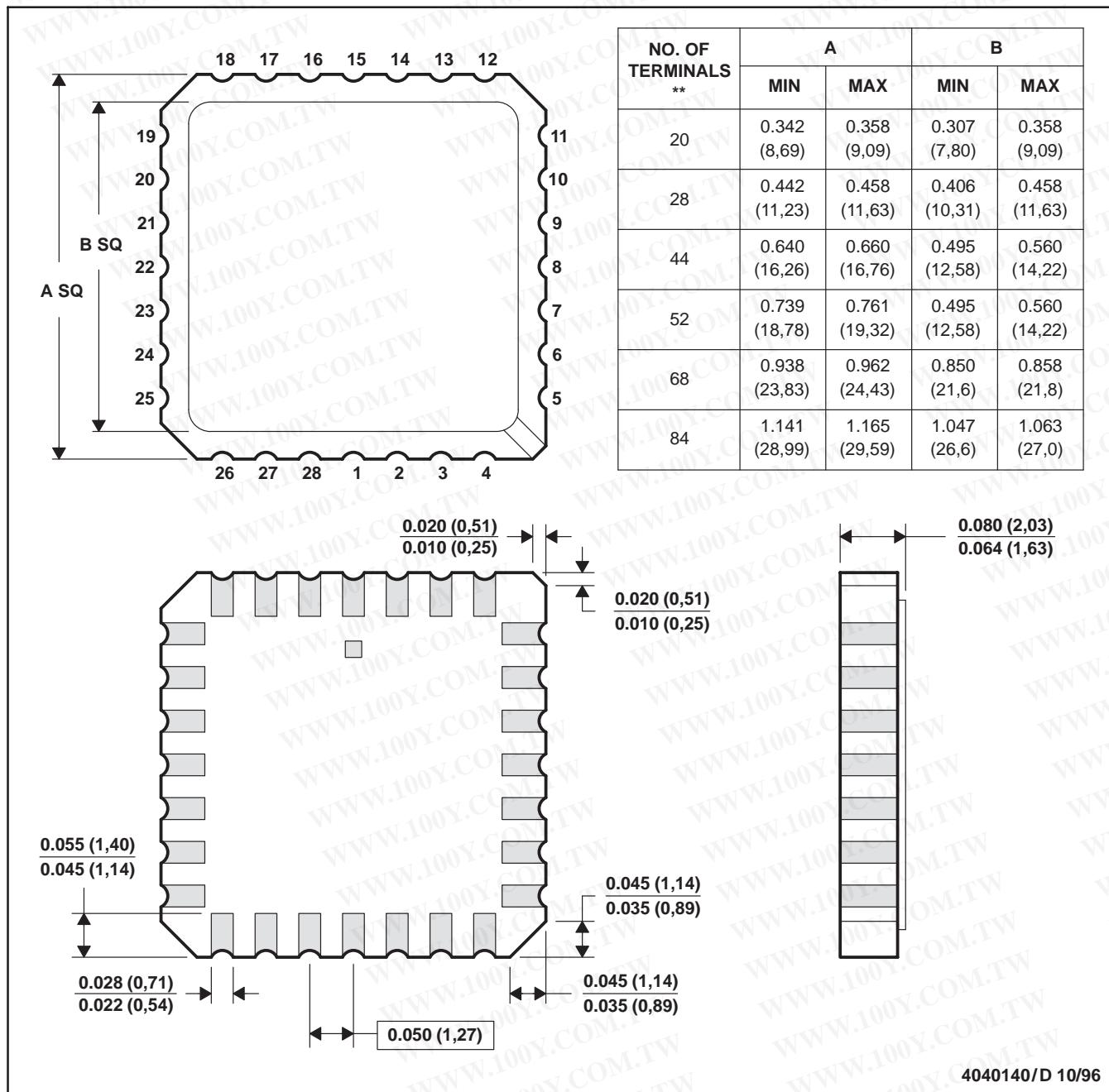


- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package can be hermetically sealed with a ceramic lid using glass frit.
 - Index point is provided on cap for terminal identification only.
 - Falls within Mil-Std 1835 GDFP2-F20

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. This package can be hermetically sealed with a metal lid.

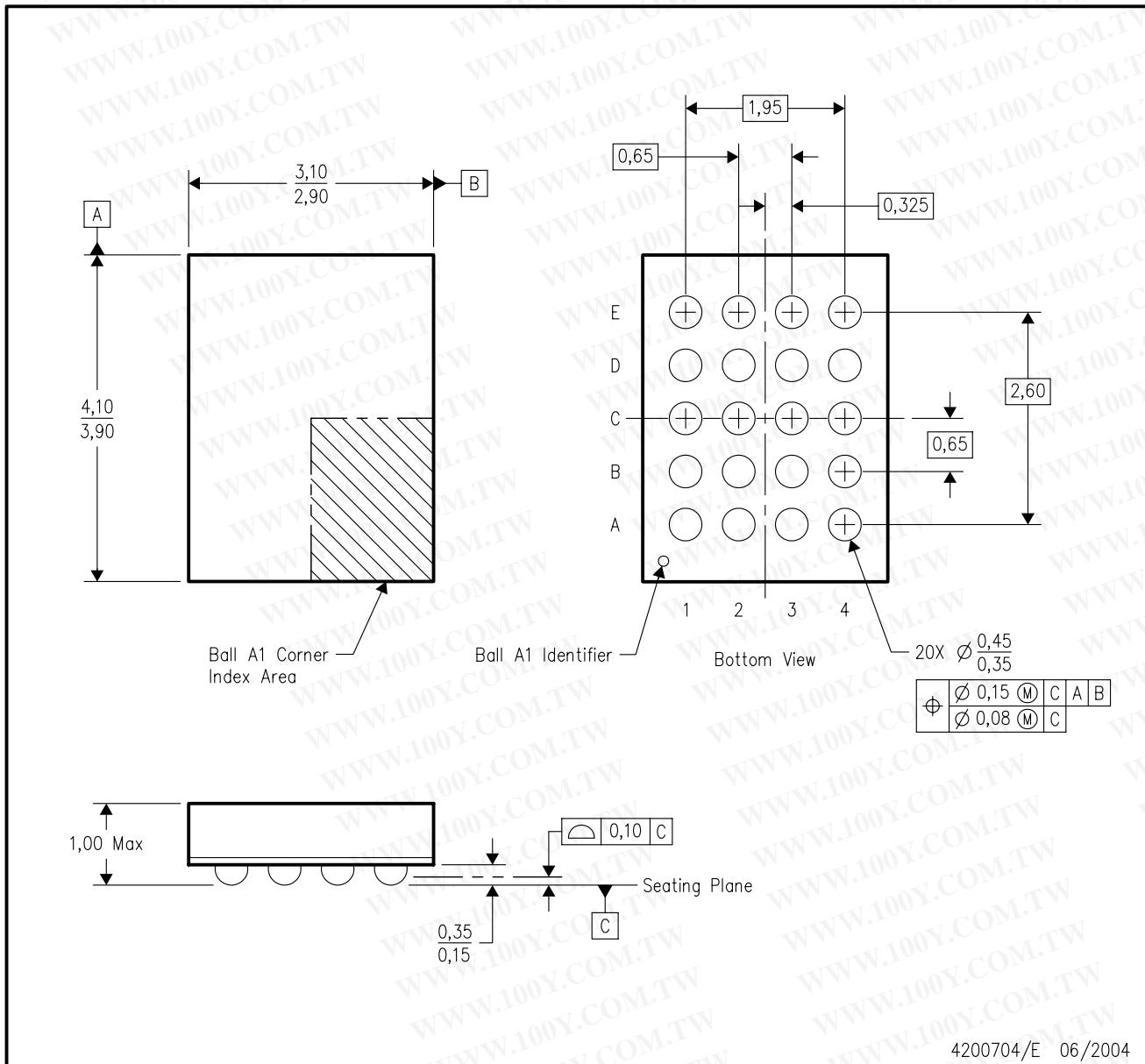
D. The terminals are gold plated.

E. Falls within JEDEC MS-004

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GQN (R-PBGA-N20)

PLASTIC BALL GRID ARRAY



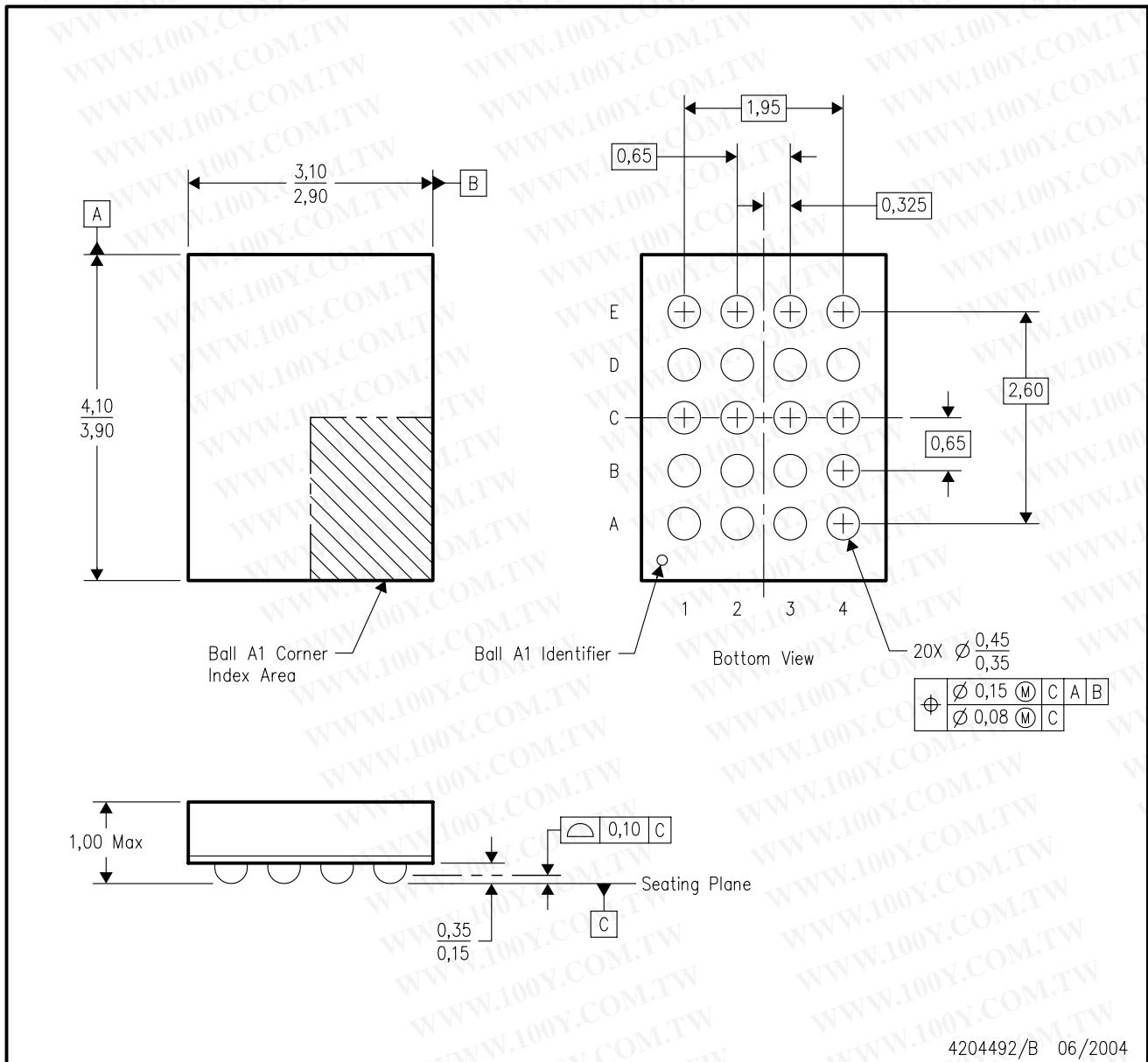
4200704/E 06/2004

- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Falls within JEDEC MO-225 variation BC.
 - This package is tin-lead (SnPb). Refer to the 20 ZQN package (drawing 4204492) for lead-free.

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ZQN (R-PBGA-N20)

PLASTIC BALL GRID ARRAY

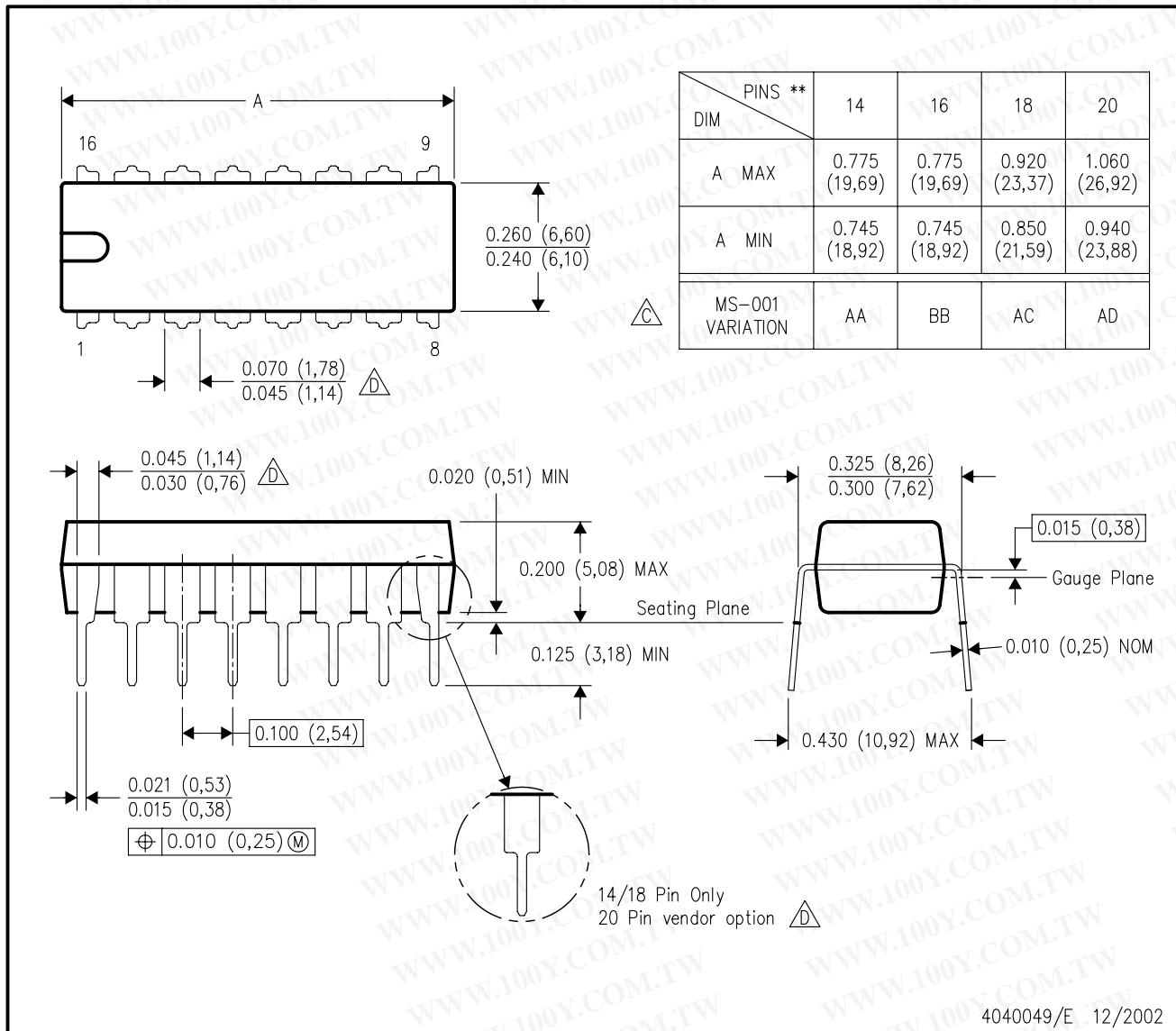


MECHANICAL DATA

N (R-PDIP-T)**

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).

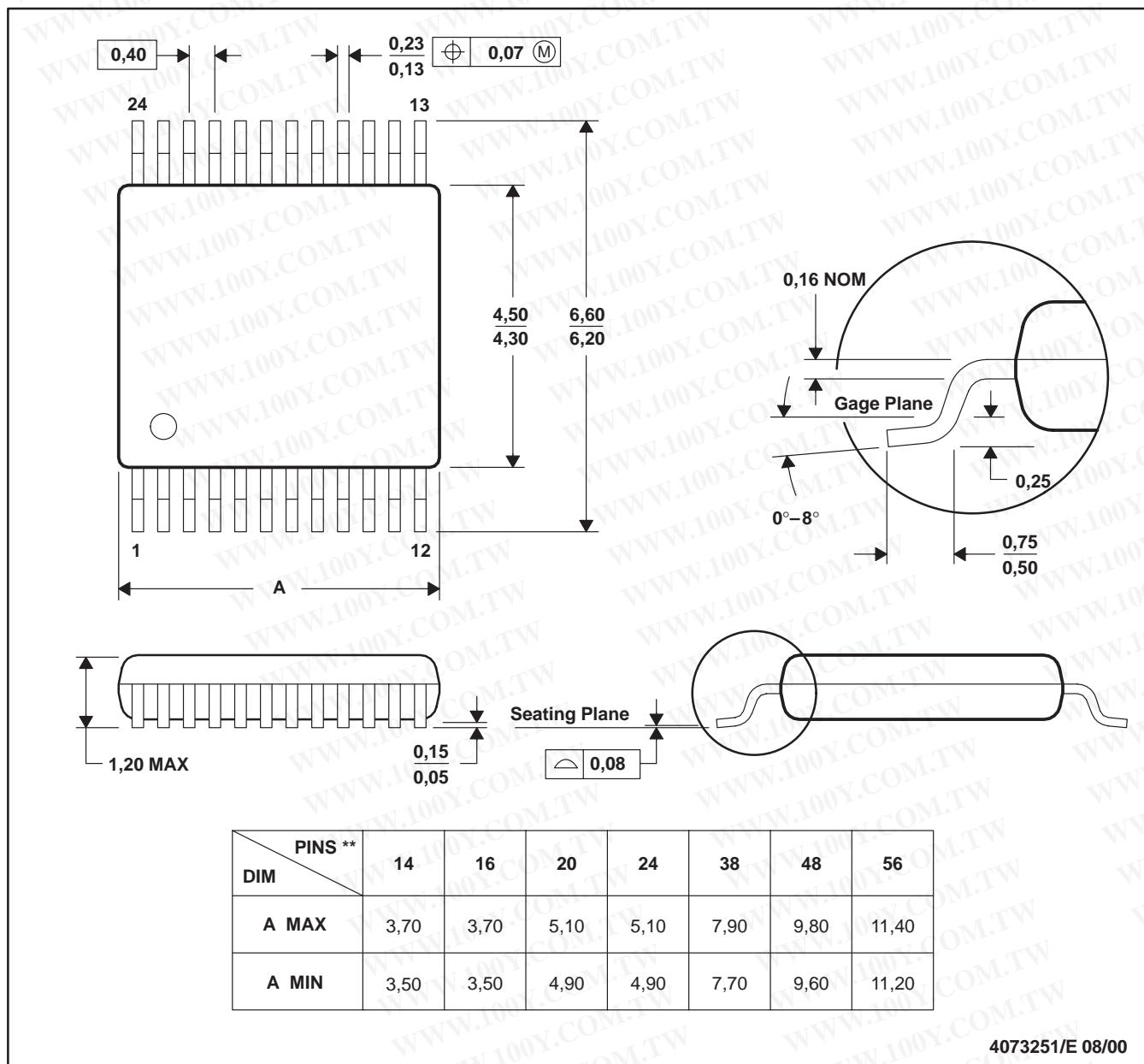
D The 20 pin end lead shoulder width is a vendor option, either half or full width.

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DGV (R-PDSO-G**)

24 PINS SHOWN

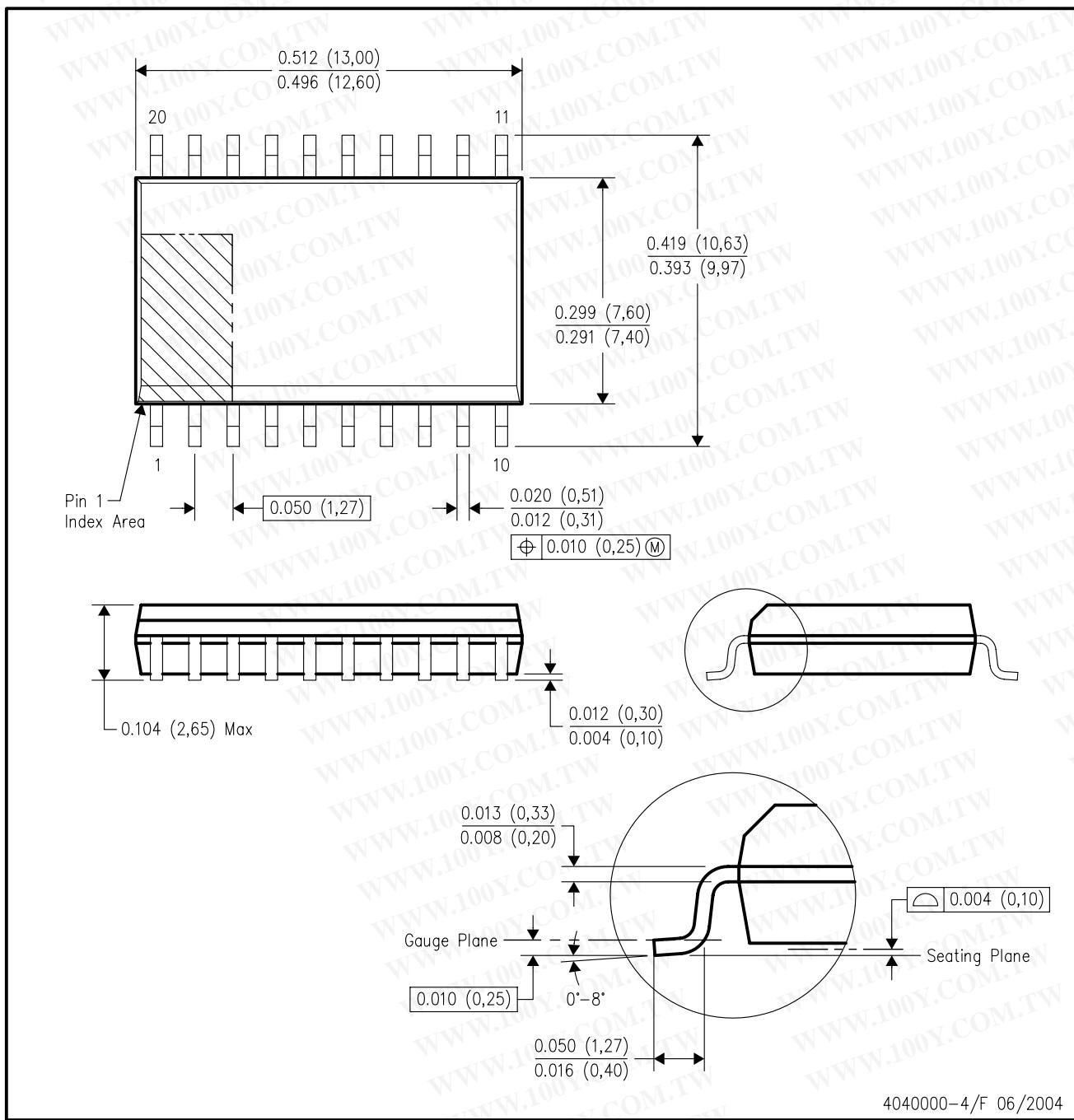
PLASTIC SMALL-OUTLINE



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
 D. Falls within JEDEC: 24/48 Pins – MO-153
 14/16/20/56 Pins – MO-194

DW (R-PDSO-G20)

PLASTIC SMALL-OUTLINE PACKAGE

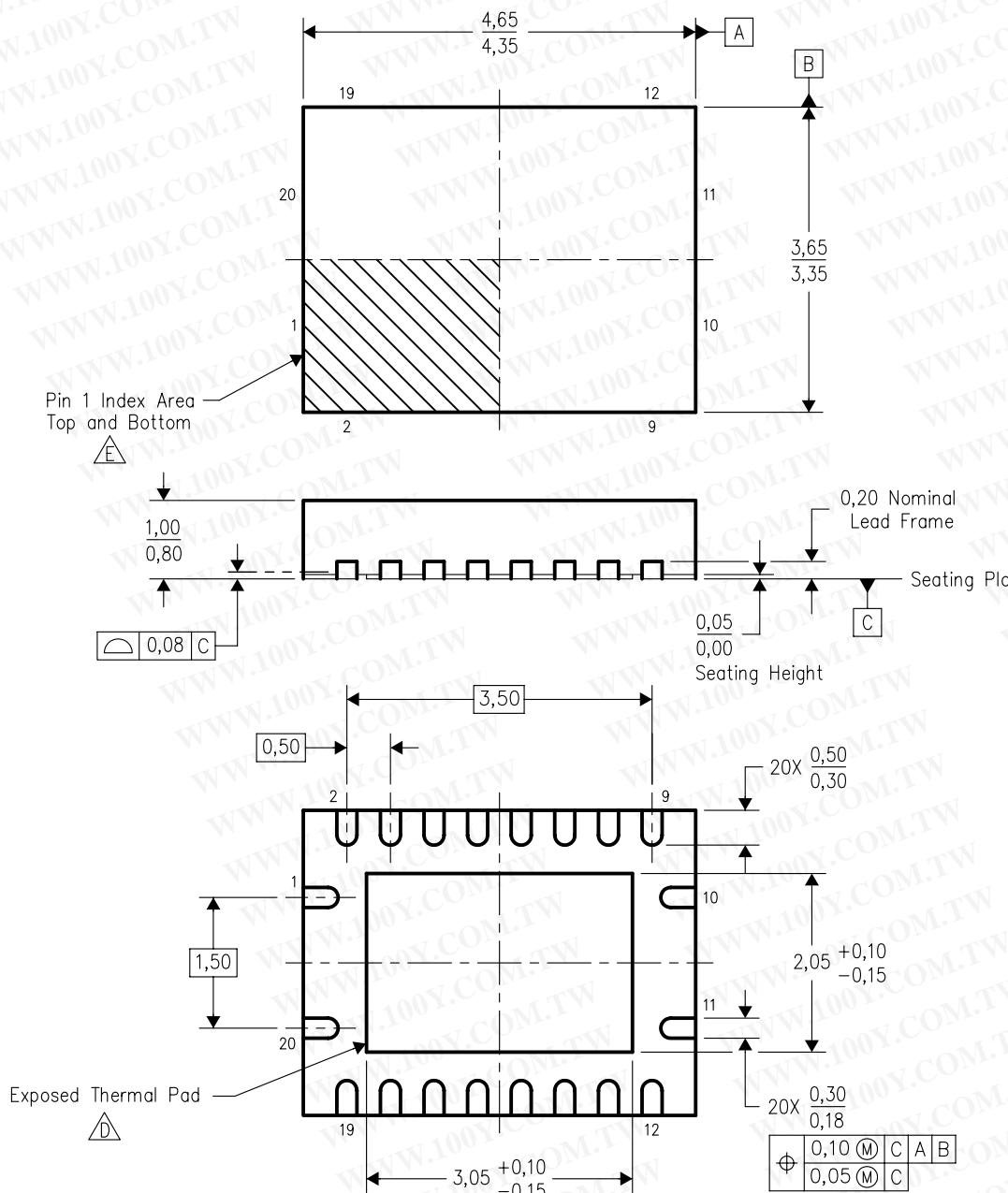


- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - D. Falls within JEDEC MS-013 variation AC.

MECHANICAL DATA

RGY (R-PQFP-N20)

PLASTIC QUAD FLATPACK



Bottom View

4203539-4/G 04/2005

- NOTES:
- All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
 - This drawing is subject to change without notice.
 - QFN (Quad Flatpack No-Lead) package configuration.

The package thermal pad must be soldered to the board for thermal and mechanical performance.

Pin 1 identifiers are located on both top and bottom of the package and within the zone indicated.
The Pin 1 identifiers are either a molded, marked, or metal feature.

F. Package complies to JEDEC MO-241 variation BC.

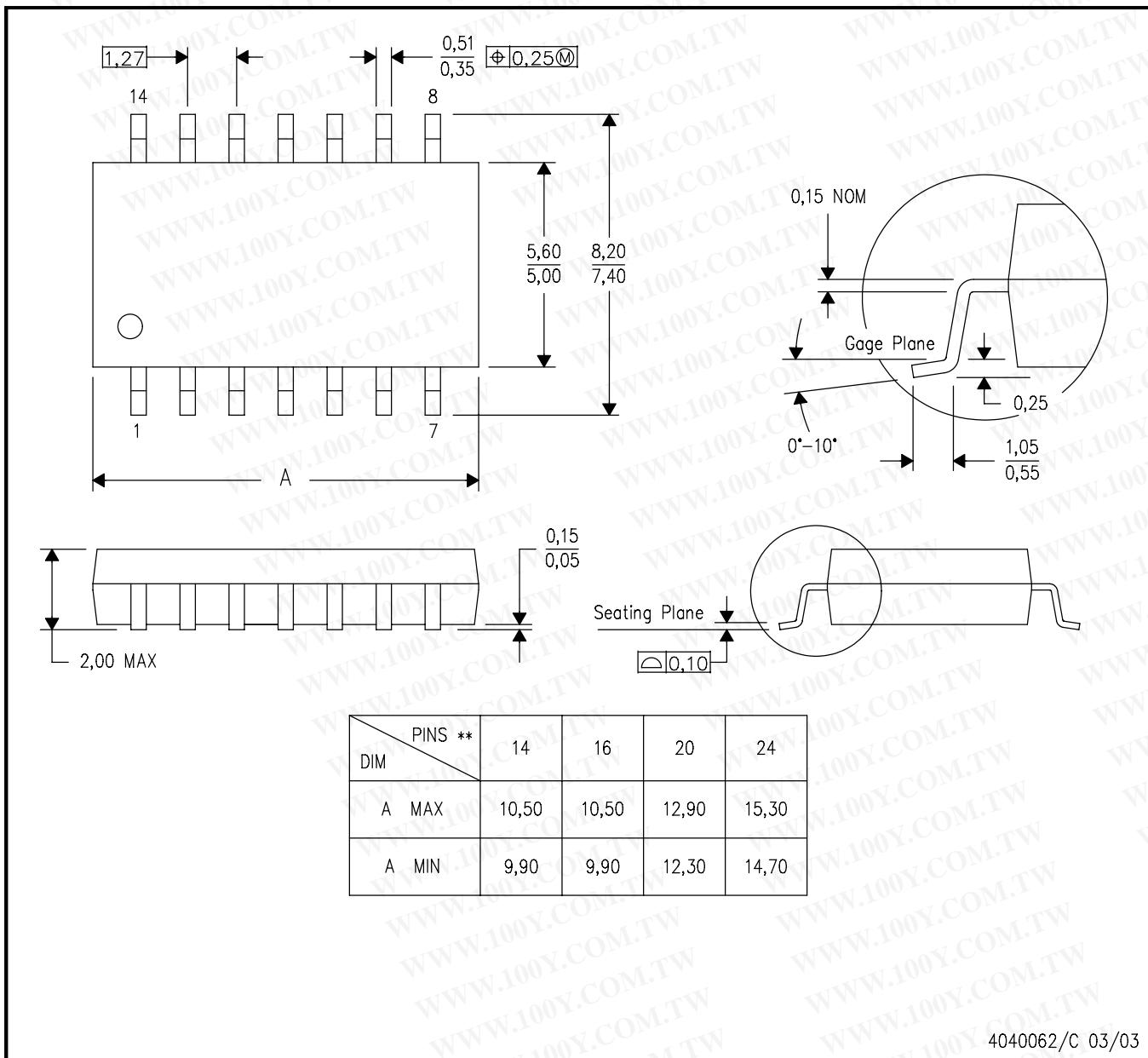
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MECHANICAL DATA

NS (R-PDSO-G)**

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

404062/C 03/03

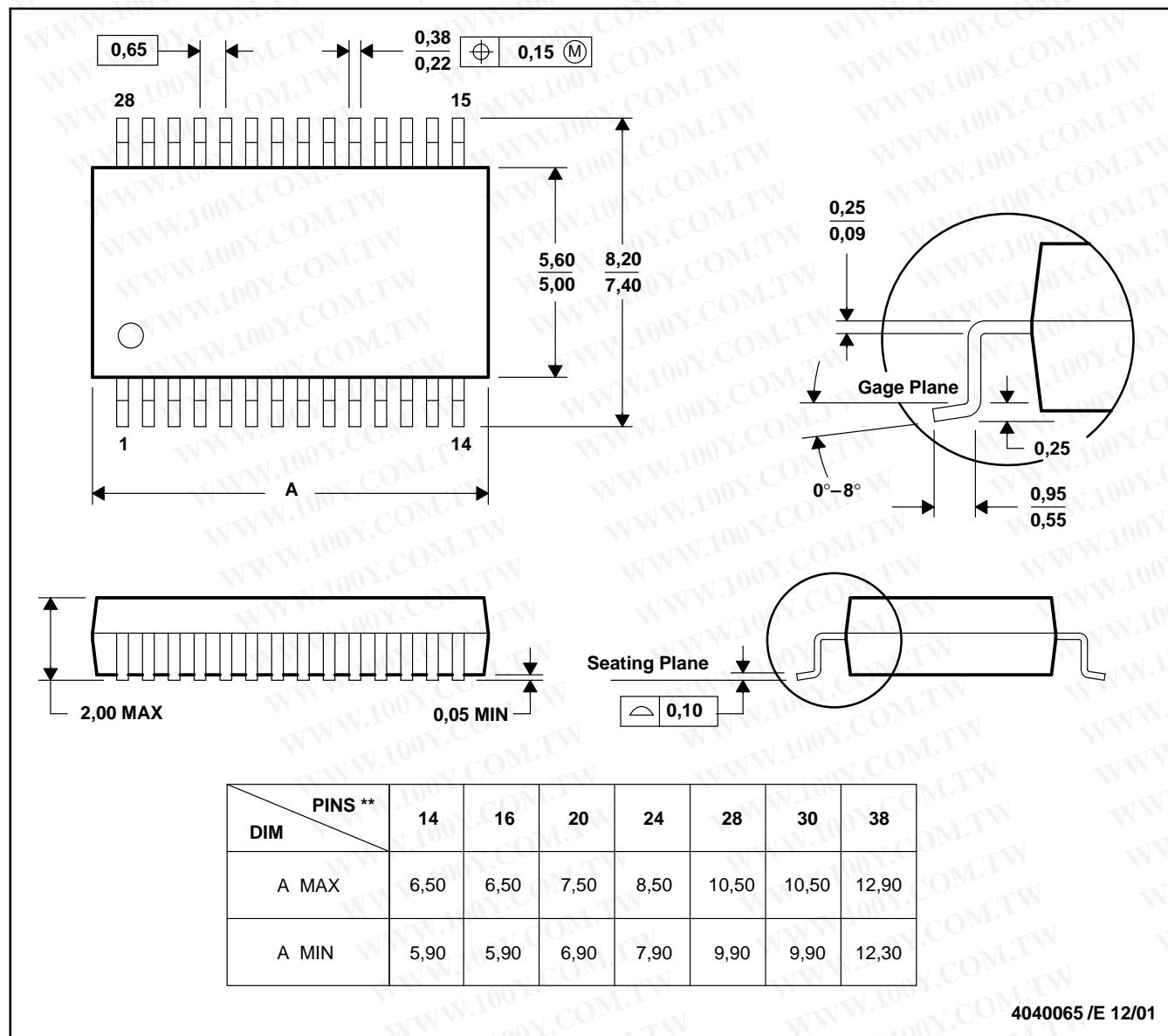
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DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-150

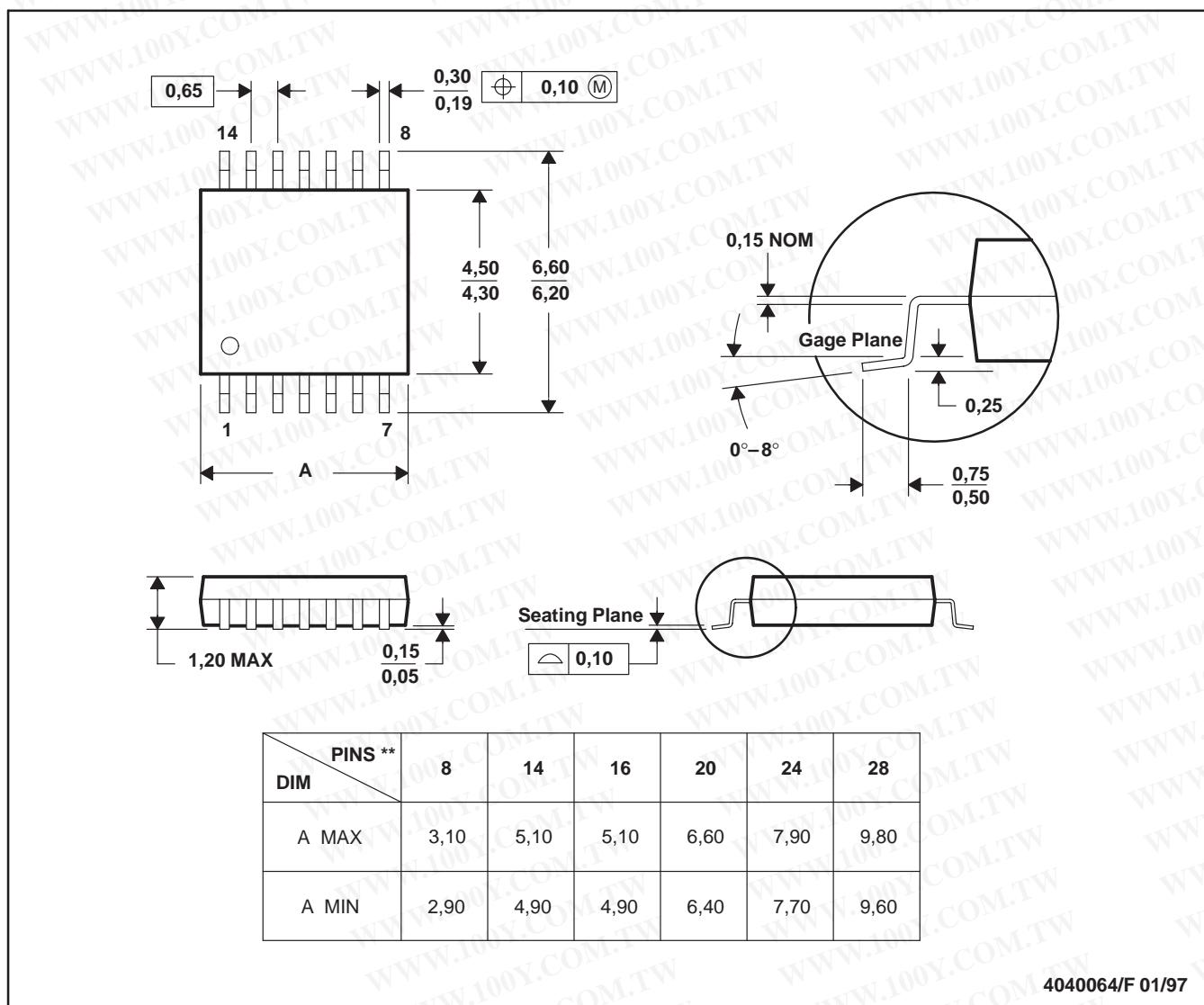
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PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 - D. Falls within JEDEC MO-153

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